



HOSTAFORM® C 9021 10/9005 - POM

Description

Eff. thermal diffusivity

Hostaform® C 9021 10/9005 is a nominal 9 melt flow rate acetal copolymer which is capable of being permanently marked by a laser. Parts molded from Hostaform® C 9021 10/9005 can be laser marked with barcodes, identification numbers, designs, 2-D symbology, etc.

Physical properties	Value	Unit	Test Standard
Density	1410	kg/m³	ISO 1183
Melt volume rate, MVR	8	cm ³ /10min	ISO 1133
MVR temperature	190	°C	ISO 1133
MVR load	2.16	kg	ISO 1133
Molding shrinkage, parallel	2.0	%	ISO 294-4, 2577
Molding shrinkage, normal	1.8	%	ISO 294-4, 2577
Water absorption, 23°C-sat	0.65	%	ISO 62
Humidity absorption, 23°C/50%RH	0.2	%	ISO 62
Mechanical properties	Value	Unit	Test Standard
Tensile modulus	2850	MPa	ISO 527-2/1A
Tensile stress at yield, 50mm/min	64	MPa	ISO 527-2/1A
Tensile strain at yield, 50mm/min	9	%	ISO 527-2/1A
Tensile nominal strain at break, 50mm/min	25	%	ISO 527-2/1A
Tensile creep modulus, 1h	2500	MPa	ISO 899-1
Tensile creep modulus, 1000h	1300	MPa	ISO 899-1
Flexural modulus, 23°C	2700	MPa	ISO 178
Charpy impact strength, 23°C	180 ^[P]	kJ/m²	ISO 178
Charpy impact strength, -30°C Charpy impact strength, -30°C	160	kJ/m²	ISO 179/1eU
			ISO 179/1e0
Charpy notched impact strength, 23°C	5.5	kJ/m²	
Charpy notched impact strength, -30°C P: Partial Break	5	kJ/m²	ISO 179/1eA
Thermal properties	Value	Unit	Test Standard
Melting temperature, 10°C/min	166	°C	ISO 11357-1/-3
DTUL at 1.8 MPa	104	°C	ISO 75-1, -2
Vicat softening temperature, 50 °C/h 50N	150	°C	ISO 306
Coeff. of linear therm expansion, parallel	1.1	E-4/°C	ISO 11359-2
Coeff. of linear therm expansion, normal	1.1	E-4/°C	ISO 11359-2
Flammability @1.6mm nom. thickn.	HB	class	UL 94
thickness tested (1.6)	1.5	mm	UL 94
UL recognition (1.6)	UL	-	UL 94
Flammability at thickness h	HB	class	UL 94
thickness tested (h)	3.00	mm -	UL 94
UL recognition (h)	UL	<u>-</u>	UL 94
Electrical properties	Value	Unit	Test Standard
	4	-	IEC 60250
Relative permittivity, 1MHz	4	-	IEC 60250
Relative permittivity, 1MHz Dissipation factor, 100Hz	4 20	- E-4	IEC 60250 IEC 60250
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz	4	-	IEC 60250
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz	4 20	- E-4	IEC 60250 IEC 60250
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity	4 20 50	- E-4 E-4	IEC 60250 IEC 60250 IEC 60250
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity	4 20 50 1E12	- E-4 E-4 Ohm*m	IEC 60250 IEC 60250 IEC 60250 IEC 60093
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength	4 20 50 1E12 1E14	- E-4 E-4 Ohm*m Ohm	IEC 60250 IEC 60250 IEC 60250 IEC 60093 IEC 60093
Relative permittivity, 100Hz Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength Comparative tracking index Rheological calculation properties	4 20 50 1E12 1E14 35	E-4 E-4 Ohm*m Ohm kV/mm	IEC 60250 IEC 60250 IEC 60250 IEC 60093 IEC 60093 IEC 60243-1
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength Comparative tracking index Rheological calculation properties	4 20 50 1E12 1E14 35 600	- E-4 E-4 Ohm*m Ohm kV/mm	IEC 60250 IEC 60250 IEC 60250 IEC 60093 IEC 60093 IEC 60243-1 IEC 60112
Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength Comparative tracking index	4 20 50 1E12 1E14 35 600	- E-4 E-4 Ohm*m Ohm kV/mm	IEC 60250 IEC 60250 IEC 60250 IEC 60093 IEC 60093 IEC 60243-1 IEC 60112

4.85E-8

 m^2/s

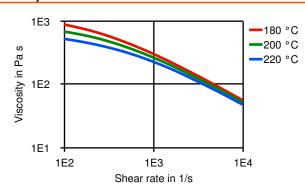
Internal

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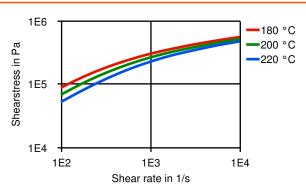
Ejection temperature	140	°C	Internal	

Diagrams

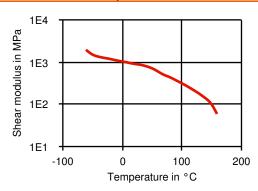
Viscosity-shear rate



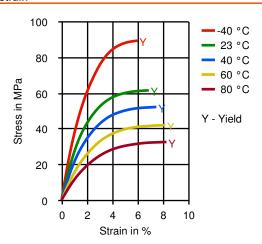
Shearstress-shear rate



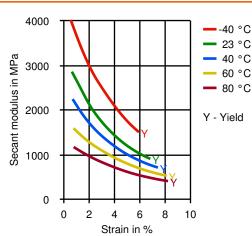
Dynamic Shear modulus-temperature



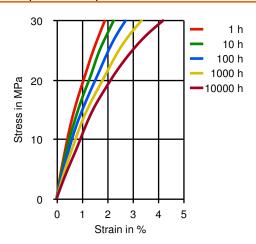
Stress-strain



Secant modulus-strain



Stress-strain (isochronous) 23°C

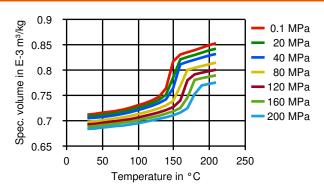


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Creep modulus-time 23°C

3000 5 MPa Creep modulus in MPa 10 MPa 2500 15 MPa 2000 20 MPa **-** 25 MPa 1500 **-** 30 MPa 1000 500 1E0 1E1 1E2 1E3 1E4 Time in h

Moldflow Specific volume-temperature (pvT)



Typical injection moulding processing conditions

Pre Drying	Value	Unit	Test Standard
Necessary low maximum residual moisture content	0.15	%	-
Drying time	3 - 4	h	-
Drying temperature	100 - 120	°C	-
Temperature	Value	Unit	Test Standard
Hopper temperature	20 - 30	°C	-
Feeding zone temperature	60 - 80	°C	-
Zone1 temperature	170 - 180	°C	-
Zone2 temperature	180 - 190	°C	-
Zone3 temperature	190 - 200	°C	-
Zone4 temperature	190 - 210	°C	-
Nozzle temperature	190 - 210	°C	-
Melt temperature	190 - 210	°C	-
Mold temperature	80 - 120	°C	-
Hot runner temperature	190 - 210	°C	-
Pressure	Value	Unit	Test Standard
Back pressure max.	40	bar	-
Speed	Value	Unit	Test Standard
Injection speed	slow-medium	-	-
Screw Speed	Value	Unit	Test Standard
Screw speed diameter, 25mm	150	RPM	-
Screw speed diameter, 40mm	100	RPM	-
Screw speed diameter, 55mm	70	RPM	-

Other text information

Pre-drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Longer pre-drying times/storage

The product can then be stored in standard conditions until processed.

Injection molding

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Melt temperature 190-210 °C Mould temperature 80-120 °C

Characteristics



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Special Characteristics	Delivery Form
Laser markable	Pellets
Product Categories	Additives
Unfilled	Release agent
Processing	_
Injection molding	

General Disclaimer

NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colorants or other additives may cause significant variations in data values. Properties of molded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any equipment, processing technique or material mentioned in this publication should satisfy themselves that they can meet all applicable safety and health standards. We strongly recommend that users seek and adhere to the manufacturer's current instructions for handling each material they use, and entrust the handling of such material to adequately trained personnel only. Please call the telephone numbers listed for additional technical information. Call Customer Services for the appropriate Materials Safety Data Sheets (MSDS) before attempting to process our products. The products mentioned herein are not intended for use in medical or dental implants.

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